India's Electronics Market

Electronics Industry – projection by segment

	Target			
(USD billion)	2014	2020		
Semiconductor design	20.0	58.2		
High-tech manufacturing	4.0	22.6		
Electronic components	2.6	3.4		
Electronic Manufacturing Services	1.4	2.3		
Electronic systems				
IT systems and hardware	16.7	54.4		
Telecom products and equipments	29.5	153.5		
Consumer electronics	8.1	17,8		
Others (Industrial, Automotive and others)	2.7	7.8		
Exports	15.0	80.0		
Total of all segments	100.0	400.0		
Source Industry estimates	Source: ISA, Inc	dia		

- India imports > 90%
 of its electronics
 equipment.
- Import is estimated to exceed US \$300B in future
- → Electronics import may exceed the petroleum import

!!! Because India missed the semiconductor revolution !!!



Indian Institute of Technology Kanpur

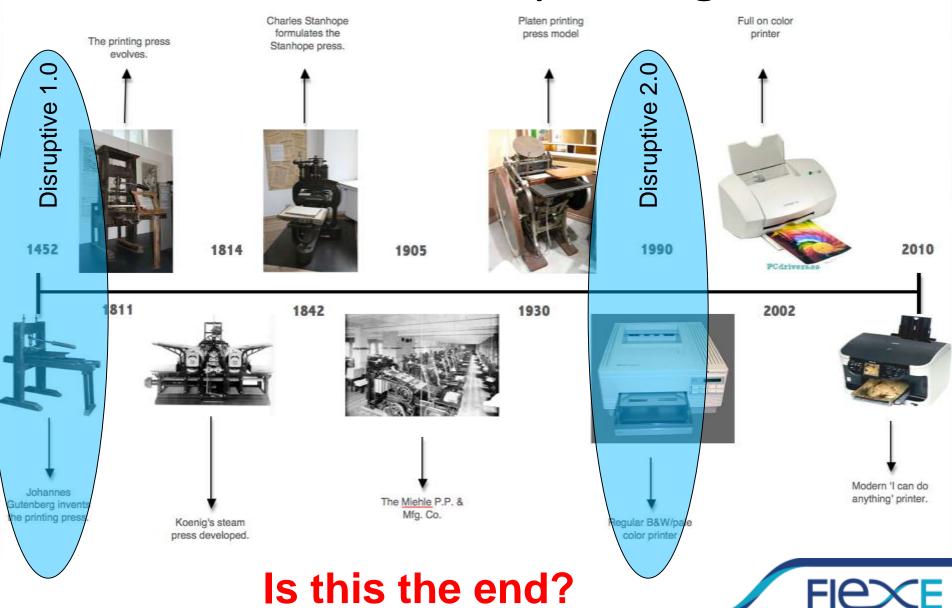


National Centre for Flexible Electronics

"Printed Electronics – Challenges and Opportunities for India"

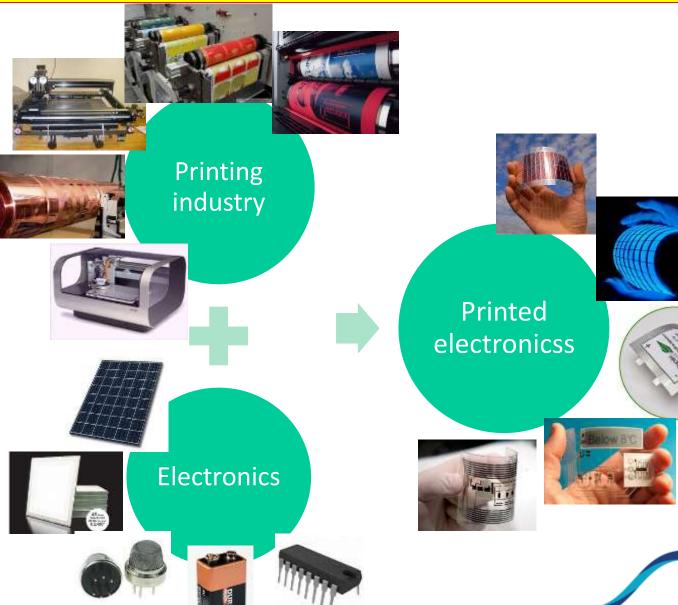
Ashutosh Tripathi, FlexE Centre, IIT Kanpur

Evolution of printing



National Centre for Flexible Electronics

Disruptive 3.0: Printed Electronics





Why printing of electronics?

Low Production Costs!

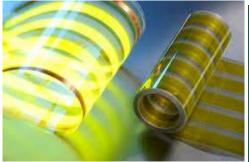
- Solution processing enables fast printing and coating technologies
- Easy to pattern
- High Speed
- Large area
- No expensive vacuum technology
- No time loss by waiting for vacuum
- Multiple layer deposition

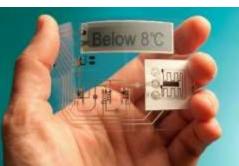
Advantages of flexible substrates

- Flexible
- Any size, any shape
- Non fragile
- From transparent to opaque
- Light weight
- Low cost
- New form factors









www.Printedelectronicsarena.com

Konarka

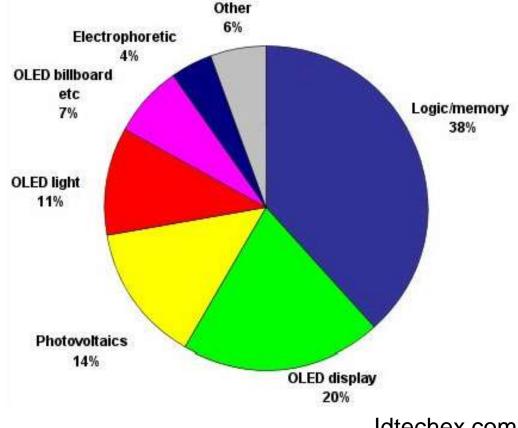
VTT

Thin Film



Printed electronics market?

Market forecasts to 2027 - a \$330 billion market



Idtechex.com

We cannot afford to miss this opportunity



Introduction to FlexE Centre



National Centre for Flexible Electronics was established in 2014 through a grant from Department of Electronics and Information Technology (DeitY) under ESDM scheme of Electronics Policy 2012 of Gol and support from IIT Kanpur

www.ncflexe.in

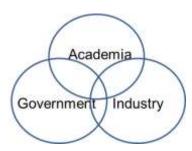


Timeline

2000

Samtel Centre for Display Technologies --- Organic Electronics





Co-development with industry

2005

2007

Country's first major programme on Printable Electronics



 Π Π

ШШ

Demonstrated –
Country's first passive
matrix OLED display
meeting industry standards





2014

National Centre for Flexible Electronics



Other Technology Programmes



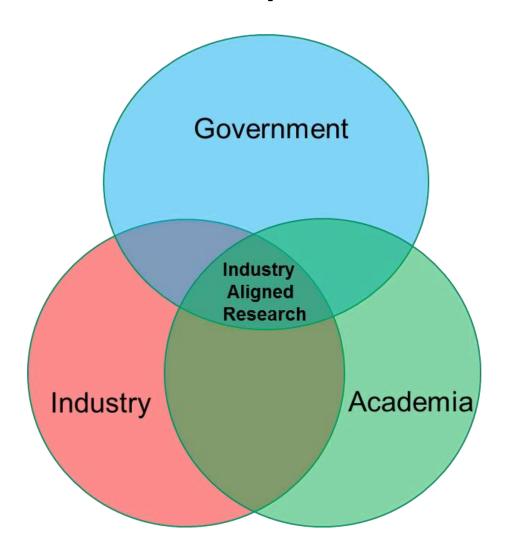




Sensors

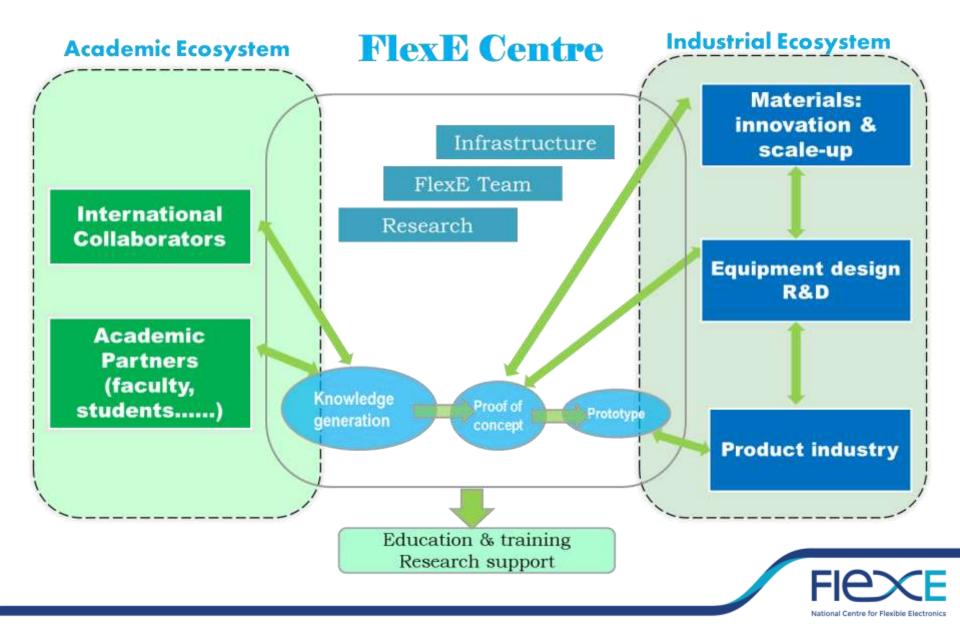


FlexE Centre – Tripartite Partnership





Bridge Between Academia and Industry



Grant from MEITY (ESDM scheme of Electronics Policy 2012 of Gol) and support from IIT Kanpur

Vision

Conduct research and development in large area flexible electronics that serves as a foundation for development of domestic industry in this field.

Objectives

R&D: In the field of large area flexible electronics

Manufacturing: Partnership with industry leading to manufacturing

Ecosystems: Facilitate formation of industrial ecosystem

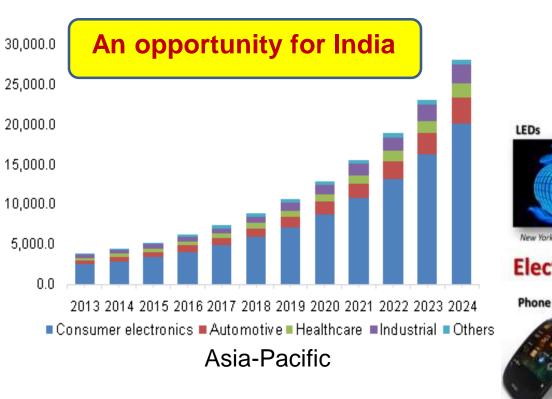
Entrepreneurship: Incubate small scale industry

International Partnerships: Build strategic partnerships

Human Resources: Skill development



Flexible Electronics



2015 - ESDM World 2T USD India 88B USD



Smart watch

LG Electronics (2013)





Solar cells

PowerFilm Solar (2010)

Vision and Objectives

Vision: Conduct R&D in large area flexible electronics that serves as a foundation for development of domestic industry in this field.

Objectives

R&D: In the field of large area flexible electronics

Manufacturing: Partnership with industry leading to manufacturing

Ecosystems: Facilitate formation of industrial ecosystem

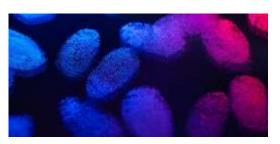
Entrepreneurship: Incubate small scale industry

International Partnerships: Build strategic partnerships

Human Resources: Skill development



Canvas: The Indian Context









Unmet technological needs

- Anti-counterfeiting Technologies
- Point of Care Diagnostics (Healthcare)
- Food safety (Healthcare)
- Portable photovoltaic systems (Energy)
- Signage (indigenization)
- Defense components (indigenization)
- Educational kits

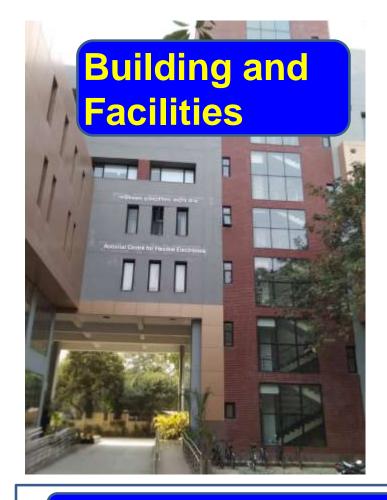












People

- → Faculty members
- → Project staff
- → Research Engineers
- → Industry personnel

~ 100

Industry Focus

Industry members – 20 NDAs - 74

Technology platform

Components and Systems

Skill Development



Facilities

A. Processing and device fabrication

Lab scale







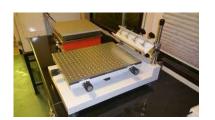
Solution processing (primary)

Vacuum processing (in addition)











Industry scale



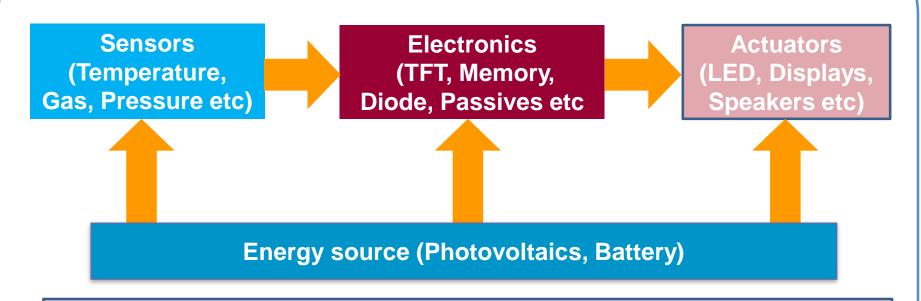


B. Materials and Electrical characterization



Technology Platform

System on Plastic/Paper/Cloth



Printing of circuits on flexible substrates



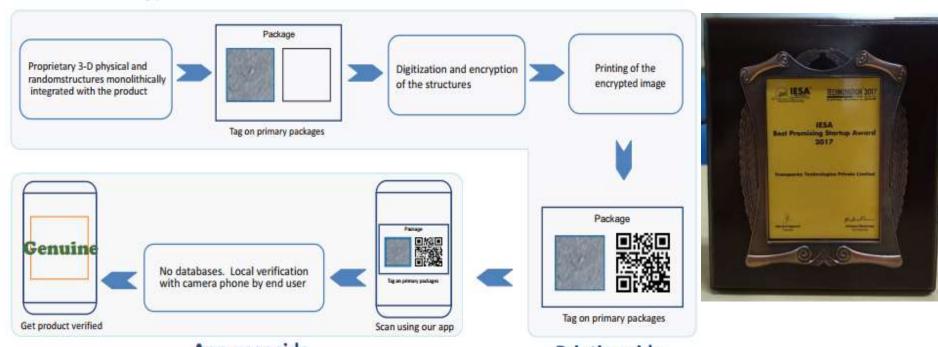
NCFlexE Technology Matrix

Technology Integration Technology Platforms				Memory and logic circuits	Flexible solar modules	Anti- counterfeiting	Healthcare devices	Flexible Displays	Smart Packaging
Large area printing and coating	Substrates and encapsulation	Patterning technologies	TFT	V		V	√	V	4
			OLED					√	1
			OPV		V				1
			Sensors			√	1		1
			Inks		V	√	1		1
			Battery	√	V	√	1		1
Common – platforms		n –		Passive components					
				Electronics and device integration					



Incubation

1. Anti-counterfeiting Tags



App user side Company incubated

Printing side



Ag inkjet ink





Cu inkjet Ink



Printing Technology development



- Printing of functional inks
 - metallic, dielectric, organic, semiconductor etc.
- Printing technology established:
 - Inkjet, SlotDie, Screen printing, Wirebar,
 Doctorblade, Flexo, Gravure
- Advanced curing technology established:
 - Flash Sintering, NIR drying, UV
- Printing of functional devices
 (in group and process support for other groups)
 - OLED
 - OPV
 - Heater
 - RFID
 - Resistive and conductive structures
 - Circuitry
 - Battery

4 PHASES

- Device Development
 Standard Semiconductor
 Processing
- 2. All Solution Processed Spin Coating Substractive Patterning
- Sheet-to-sheet Printing
 Industrial compatible
 Technology on Sheet-to-sheet level
- 4. Roll-to-roll Printing
 High throughput



Device

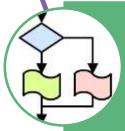


Printing Expertise



Dedicated Team

Project engineers, Technicians with printing degree/experience



Theoretical understanding

Predicting & Modeling printing behavior Ink characterization Resolving Printing issues



Printing process development

Printing of functional inks
Printing parameters for different printing technologies
Pre- and Post-treatment



Printing of functional devices

Printing process according to device requirements Choice of technology and ink vs. functionality



Printed Heater

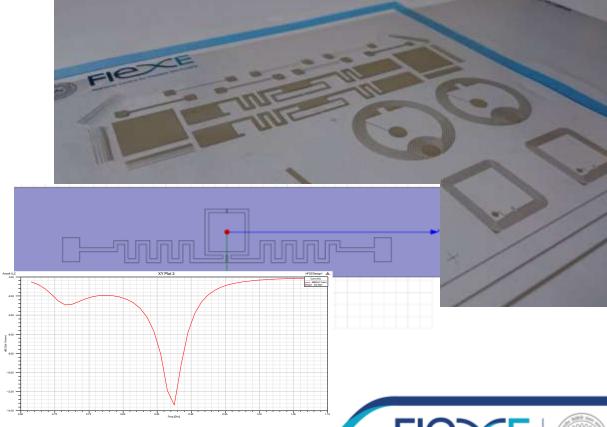
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Printed RFID Antenna





Sensors

Thermal sensors

- smart packaging
- medical diagnostics
- wearable electronics

Biomarker sensors

medical diagnostics

Gas sensors

- smart packaging
- medical diagnostics
- wearable electronics
- environmental

Aqueous metal ion sensors

- medical diagnostics
- wearable electronics
- environmental



Round Tables and Road Shows

4 (Delhi, Ahmedabad, Hyderabad, Bangalore)

Industry tradeshows (selected)

Make in India PAMEX

IESA Screen Printers Association

SID Display Week CeBIT

ASSOCHAM Indo-Japan JWG

LOPEC

Industry associations

IESA, AIMED, FICCI, ASSOCHAM, CII, CEAMA, MAIT

IDTechEx, FlexTech Alliance, Fraunhofer



Skill Development

Technical project staff: 136

Students: Ph.D. (50), M.Tech. (90)

Post-doctoral: 4

Faculty exchange: 2 (TEQIP)

Graduate level course: "Introduction to Flexible Electronics" (EE698N)

Annual Short Course on Flexible Electronics (1st full week of July)

Year	Research Scholar	Faculty/ Scientist	Industries	Total
2019	2 (Meity Intern)		23	25
2018	32	5	6	43
2017	42	5	5	52
2016	34	6	5	45
2015	18	5	4	27

Instructors from:

^{*} IIT Kanpur * Institutes in India * Institutes outside India



Summary

Intent

- Flexible Electronics An opportunity for India
- Unmet technological needs

Context

- Industry aligned research
- Bridge between academia and industry

Achievement

- Building/infra in place, Team in place
- Competency building components/systems
- Industry projects, incubation

Set to accelerate the activities



Thank you

